

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE60P25 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge .This device is well suited for high current load applications.

General Features

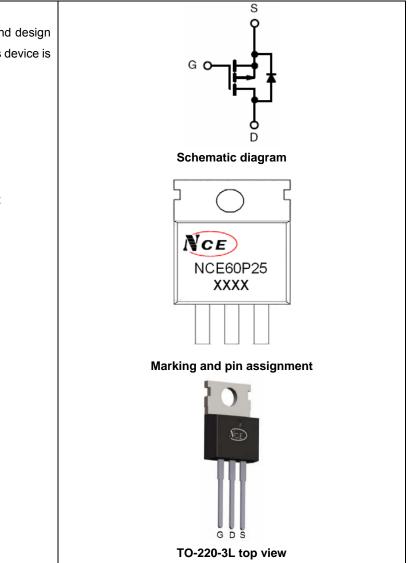
- V_{DS} =-60V,I_D =-25A
 R_{DS(ON)} <45mΩ @ V_{GS}=-10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- High side switch for full bridge converter
- DC/DC converter for LCD display

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

	•	0			
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE60P25	NCE60P25	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-60	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	-25	А
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	-17.7	A
Pulsed Drain Current	I _{DM}	-60	A
Maximum Power Dissipation	PD	90	W
Derating factor		0.72	W/°C





NCE60P25

Single pulse avalanche energy (Note 5)	E _{AS}	300	mJ
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{ ext{ hetaJC}}$	1.4	°C/W

Electrical Characteristics (T_C=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·		•			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250µA	-2	-2.9	-3.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-20A	-	39	45	mΩ
Forward Transconductance	g fs	V _{DS} =-10V,I _D =-10A	-	25	-	S
Dynamic Characteristics (Note4)	·		•			
Input Capacitance	C _{lss}	$y_{1} = 20y_{1}y_{1} = 0y_{1}$	-	3430	-	PF
Output Capacitance	C _{oss}	V _{DS} =-30V,V _{GS} =0V, F=1.0MHz	-	391	-	PF
Reverse Transfer Capacitance	C _{rss}		-	272	-	PF
Switching Characteristics (Note 4)	·		•			
Turn-on Delay Time	t _{d(on)}		-	12	-	nS
Turn-on Rise Time	tr	V_{DD} =-30V, R _L =1.5 Ω ,	-	15	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-10V,R _G =3Ω	-	38	-	nS
Turn-Off Fall Time	t _f	-		15	-	nS
Total Gate Charge	Qg	V = 20 L = 20 A	-	46		nC
Gate-Source Charge	Q _{gs}	V _{DS} =-30,I _D =-20A, V _{GS} =-10V	-	9.5		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V		10.5		nC
Drain-Source Diode Characteristics	·		•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-10A	-		-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-25	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =- 10A	-	47		nS
Reverse Recovery Charge	Qrr	di/dt = -100A/µs(Note3)	-	53		nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, t \leq 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- **5.** E_{AS} condition: Tj=25 $^{\circ}$ C,V_{DD}=-20V,V_G=-10V,L=1mH,Rg=25 Ω ,I_{AS}=33A

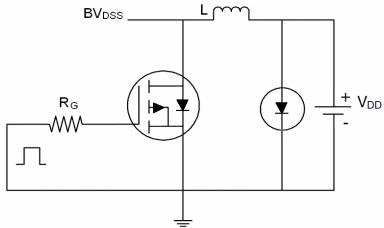


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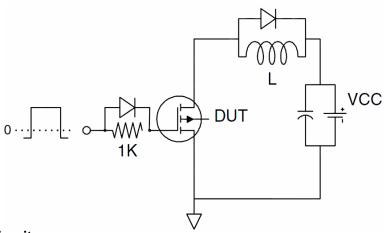




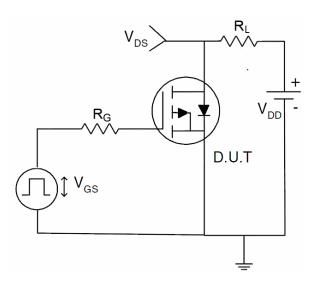
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



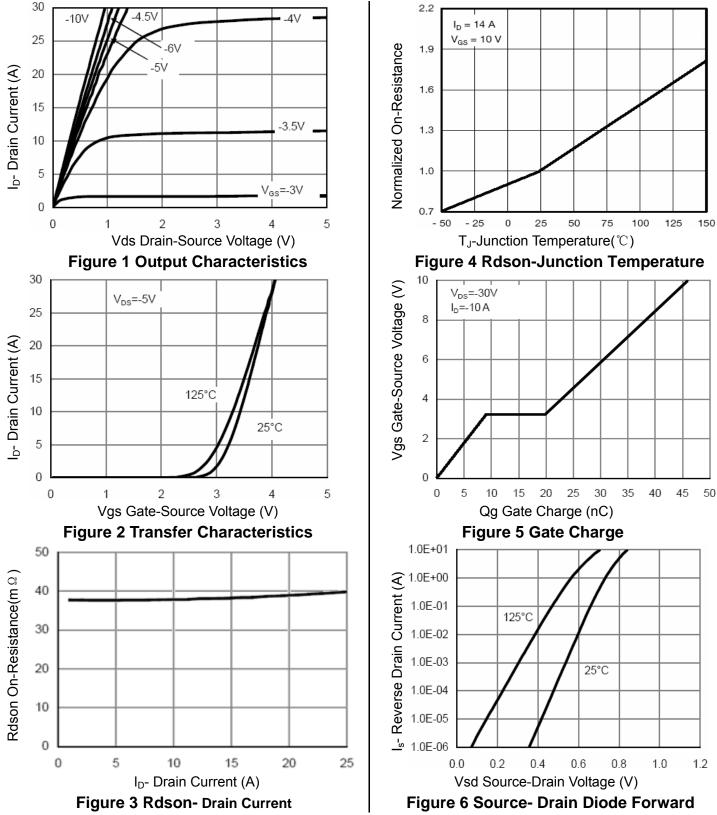
3) Switch Time Test Circuit













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Pb Free Product

NCE60P25

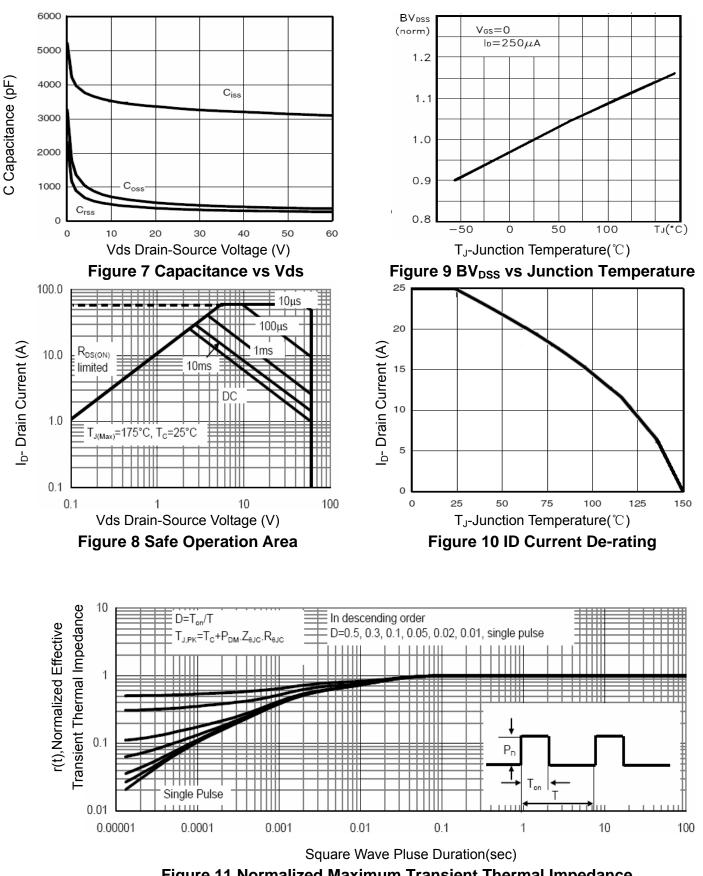


Figure 11 Normalized Maximum Transient Thermal Impedance

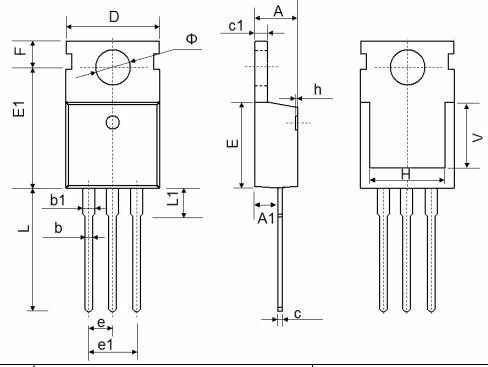


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NCE60P25

TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimension	s In Inches	
Symbol	Min.	Max.	Min.	Max.	
А	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540	TYP.	0.100	TYP.	
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		0.295 REF.		
Ф	3.400	3.800	0.134	0.150	







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